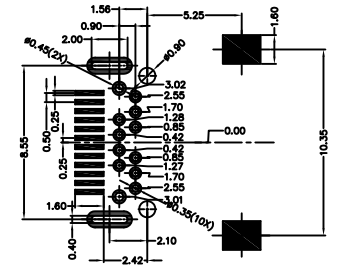


- REMARKS:
- MATERIAL:
 - HOUSING: LCP+30%G.F UL94V-0
 - CONTACT: COPPER ALLOY, T=0.12mm; Nickle Plate
Over all, Au Plate Xμ" on contact area.
 - SHIELDED: STAINLESS STEEL, T=0.30mm;
100 μ"Nickle or 100 μ" Bright Tin.
 - GROUNDING: STAINLESS STEEL, T=0.10mm.
 - SPECIFICATIONS:
 - CURRENT: 5A
 - CONTACT RESISTANCE: 30mΩ MAX
 - INSULATION RESISTANCE: 100MΩ MIN 250V DC
 - DIELECTRIC WITHSTANDING VOLTAGE: 250V AC
 - SOLDER ABILITY: Temp 250±5°C, Time 5±0.5s
 - INSERTION FORCE : 3.57kgf MAX
PULL OUT FORCE: 1.02kgf MIN
 - LIFE TEST: 10000 CYCLES
 - OPERATING TEMPERATURE: -30°C ~+80°C



Champyang International Ltd., Co

FILE NO :	AUC04 (Series)
TOLERANCE(公差):	0.000 mm ± 0.075 mm 0.00 mm ± 0.15 mm 0.0 mm ± 0.25 mm
A0	RELEASED
REV	DESCRIPTION.
APPD.	Allen
Date	2019-07-01

TITLE	USB 3.1Type-C Socket DIP+SMT (Lengthen)			UNIT	mm
圖名				單位	inch
PART NO.	AUC04-0124-141-SD-A			SCALE	1:1
料號				比例	
DRAWN BY	Ben	DATE	2019-07-01	REV.	A.0
製圖		日期		版本	
CHECKED BY	Allen	DATE	2019-07-01		
審核		日期			